







SN74AXCH1T45 SCES883C - DECEMBER 2018 - REVISED SEPTEMBER 2020

SN74AXCH1T45 Single-Bit Dual-Supply Bus Transceiver with Configurable Voltage Translation, Tri-State Outputs, and Bus-Hold Inputs

1 Features

- Fully Configurable Dual-Rail Design Allows Each Port to Operate With a Power Supply Range from 0.65 V to 3.6 V
- Operating Temperature: -40°C to +125°C
- Glitch-Free Power Supply Sequencing
- Bus-hold on Data Inputs Eliminates the Need for External Pullup or Pulldown Resistors
- Maximum Quiescent Current ($I_{CCA} + I_{CCB}$) of 10 μA (85°C Maximum) and 16 μA (125°C Maximum)
- Up to 500-Mbps Support When Translating from 1.8 to 3.3 V
- V_{CC} Isolation Feature
 - If Either V_{CC} Input is Below 100 mV, All I/Os Outputs are Disabled and Become High-**Impedance**
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human Body Model
 - 1000-V Charged-Device Model

2 Applications

- Personal Electronics
- **Enterprise and Communications**
- Wireless Infrastructure
- **Building Automation**
- Electronic Point of Sale
- **Enterprise Solid State Drive**

3 Description

The SN74AXCH1T45 is a single-bit noninverting bus transceiver that uses two individually configurable power-supply rails. The device is operational with both V_{CCA} and V_{CCB} supplies as low as 0.65 V. The A port is designed to track V_{CCA}, which accepts any supply voltage from 0.65 V to 3.6 V. The B port is designed to track V_{CCB}, which also accepts any supply voltage from 0.65 V to 3.6 V. Additionally the SN74AXCH1T45 is compatible with a single-supply system.

The DIR pin determines the direction of signal propagation. With the DIR pin configured HIGH, translation is from Port A to Port B. With DIR configured LOW, translation is from Port B to Port A. The DIR pin is referenced to V_{CCA}, meaning that its logic-high and logic-low thresholds track with V_{CCA}.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended. If a supply is present for V_{CCA} or V_{CCB}, the bus-hold circuitry always remains active on the A or B inputs respectively, independent of the state of the direction control pin.

This device is fully specified for partial-power-down applications using the Ioff current. The Ioff protection circuitry ensures that no excessive current is drawn from or to an input, output, or combined I/O that is biased to a specific voltage while the device is powered down.

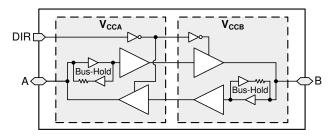
The V_{CC} isolation feature ensures that if either V_{CCA} or V_{CCB} is less than 100 mV, both I/O ports enter a high-impedance state by disabling their outputs.

Glitch-free power supply sequencing allows either supply rail to be powered on or off in any order while providing robust power sequencing performance.

Device Information

| PART NUMBER | PACKAGE ⁽¹⁾ | BODY SIZE (NOM) |
|-----------------|------------------------|-------------------|
| SN74AXCH1T45DBV | SOT-23 (6) | 2.90 mm × 1.60 mm |
| SN74AXCH1T45DCK | SC70 (6) | 2.00 mm × 1.25 mm |
| SN74AXCH1T45DTQ | X2SON (6) | 1.00 mm x 0.80 mm |
| SN74AXCH1T45DRY | SON (6) | 1.40 mm x 1.00 mm |

For all available packages, see the orderable addendum at the end of the data sheet.



Functional Block Diagram



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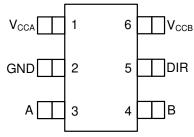
4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision B (June 2020) to Revision C (September 2020) | Page |
|--|------|
| Updated I_{CCA}, I_{CCB}, and I_{CCA} + I_{CCB} to reflect updated performance of device | 6 |
| Changes from Revision A (January 2019) to Revision B (June 2020) | Page |
| Added DRY package option to Device Information table | 1 |
| Added pinout drawing for DRY package | |
| Changes from Revision * (December 2018) to Revision A (January 2019) | Page |
| Added DBV and DTQ package options to Device Information table | 1 |
| Updated Revision History section | |
| Added pinout drawings for DBV and DTQ packages | |
| Added DRY package to Pin Configurations | |
| , , | |



5 Pin Configuration and Functions



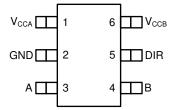


Figure 5-2. DCK Package 6-Pin SC70 Top View

Figure 5-1. DBV Package 6-Pin SOT-23 Top View

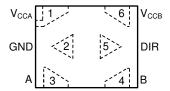




Figure 5-3. DTQ Package 6-Pin X2SON Transparent Top View

Figure 5-4. DRY Package 6-Pin SON Transparent Top View

Pin Functions

| P | 'IN | TYPE | DESCRIPTION |
|----------------------|------------------|------|--|
| NO. | NAME | ITPE | DESCRIPTION |
| 1 | V _{CCA} | _ | A-port supply voltage. 0.65 V ≤ V _{CCA} ≤ 3.6 V. |
| 2 | GND | _ | Ground |
| 3 | Α | I/O | Input/output A. This pin is referenced to V _{CCA} . |
| 4 | В | I/O | Input/output B. This pin is referenced to V _{CCB} . |
| 5 | DIR | I | Direction control signal. See for functionality. |
| 6 V _{CCB} — | | | B-port supply voltage. $0.65 \text{ V} \leq \text{V}_{\text{CCB}} \leq 3.6 \text{ V}.$ |

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

| | , | | MIN | MAX | UNIT |
|------------------|---|--------------------|------|------------------------|------|
| V_{CCA} | Supply voltage A | | -0.5 | 4.2 | V |
| V_{CCB} | Supply voltage B | | -0.5 | 4.2 | V |
| | | I/O Ports (A Port) | -0.5 | 4.2 | |
| V_{I} | Input Voltage ⁽²⁾ | I/O Ports (B Port) | -0.5 | 4.2 | V |
| | | Control Inputs | -0.5 | 4.2 | |
| | Valle are applied to any authorities the bigh instead on a surrough state (2) | A Port | -0.5 | 4.2 | ., |
| Vo | Voltage applied to any output in the high-impedance or power-off state ⁽²⁾ | B Port | -0.5 | 4.2 | V |
| ., | Voltage and the array authors in the bring on law state (2) (3) | A Port | -0.5 | V _{CCA} + 0.2 | V |
| Vo | Voltage applied to any output in the high or low state ^{(2) (3)} | B Port | -0.5 | V _{CCB} + 0.2 | V |
| I _{IK} | Input clamp current | V _I < 0 | -50 | | mA |
| I _{OK} | Output clamp current | V _O < 0 | -50 | | mA |
| Io | Continuous output current | - | -50 | 50 | mA |
| | Continuous current through V _{CC} or GND | | -100 | 100 | mA |
| Tj | Junction Temperature | | | 150 | °C |
| T _{stg} | Storage temperature | | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 4.2 V maximum if the output current rating is observed.

6.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| V | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | ±8000 | V |
| V _(ESD) | Liectiostatic discharge | Charged device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | ±1000 | v |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1) (2) (3)

| | | | | MIN | MAX | UNIT |
|------------------|--------------------------|--|---|-------------------------|-------------------------|------|
| V _{CCA} | Supply voltage A | | | 0.65 | 3.6 | V |
| V _{CCB} | Supply voltage B | | | 0.65 | 3.6 | V |
| | | | V _{CCI} = 0.65 V - 0.75 V | V _{CCI} x 0.70 | | |
| | | | V _{CCI} = 0.76 V - 1 V | V _{CCI} x 0.70 | | |
| | | Data Inputs | V _{CCI} = 1.1 V - 1.95 V | V _{CCI} x 0.65 | | |
| | | | V _{CCI} = 2.3 V - 2.7 V | 1.6 | | |
| . , | | | V _{CCI} = 3 V - 3.6 V | 2 | | V |
| V _{IH} | High-level input voltage | | V _{CCA} = 0.65 V - 0.75 V | V _{CCA} x 0.70 | | V |
| | | | V _{CCA} = 0.76 V - 1 V | V _{CCA} x 0.70 | | |
| | | Control Input (DIR) Referenced to V _{CCA} | V _{CCA} = 1.1 V - 1.95 V | V _{CCA} x 0.65 | | |
| | | Treferenced to VCCA | V _{CCA} = 2.3 V - 2.7 V | 1.6 | | |
| | | | V _{CCA} = 3 V - 3.6 V | 2 | | |
| | | | V _{CCI} = 0.65 V - 0.75 V | | V _{CCI} x 0.30 | |
| | | | V _{CCI} = 0.76 V - 1 V | | V _{CCI} x 0.30 | |
| | | Data Inputs | V _{CCI} = 1.1 V - 1.95 V | | V _{CCI} x 0.35 | |
| | | | V _{CCI} = 2.3 V - 2.7 V | | 0.7 | |
| , | Low-level input voltage | | V _{CCI} = 3 V - 3.6 V | | 0.8 | V |
| / _{IL} | Low-level input voltage | | V _{CCA} = 0.65 V - 0.75 V | | V _{CCA} x 0.30 | V |
| | | | V _{CCA} = 0.76 V - 1 V | | V _{CCA} x 0.30 | |
| | | Control Input (DIR) Referenced to V _{CCA} | V _{CCA} = 1.1 V - 1.95 V | | V _{CCA} x 0.35 | |
| | | COA | $V_{CCA} = 2.3 \text{ V} - 2.7 \text{ V}$ | | 0.7 | |
| | | | V _{CCA} = 3 V - 3.6 V | | 0.8 | |
| / _I | Input voltage (3) | | | 0 | 3.6 | V |
| / ₀ | Output voltage | Active State | | 0 | V _{CCO} | V |
| | Output voltage | Tri-State | 0 | 3.6 | V | |
| ∆t/∆v | Input transition rate | | | | 100 | ns/V |
| ΓΑ | Operating free-air tempe | rature | | -40 | 125 | °C |

- (1)
- VCCI is the VCC associated with the input port. VCCO is the VCC associated with the output port.
- All unused inputs of the device must be held at VCC or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs.

6.4 Thermal Information

| | | | SN74 | AXCH1T45 | | |
|-----------------------|--|-----------------|------------|----------------|-----------|------|
| | THERMAL METRIC(1) | DBV (SOT-23) | DCK (SC70) | DTQ (X2SON) | DRY (SON) | UNIT |
| | | 6 PINS | 6 PINS | 6 PINS | 6 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 214.0 | 223.9 | 327.8 | 308.3 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 151.8 | 150.9 | 194.9 | 206.4 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 93.6 | 75.3 | 248.4 | 181.7 | °C/W |
| ΨЈТ | Junction-to-top characterization parameter | 78.1 | 58.2 | 24.1 | 42.6 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 93.4 | 75.0 | 247.6 | 180.8 | °C/W |

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

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6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted) (1) (2)

| DADAMETER | | | | | | Operatin | g free-air | tempera | ature (T | A) | |
|------------------|-----------------------------------|-------------------------|---------------------------|------------------|------------------|---------------------------|------------|---------------------------|----------|------|----------|
| P | ARAMETER | TEST | CONDITIONS | V _{CCA} | V _{CCB} | -40°C to | 85°C | -40° | C to 12 | 5°C | UNI T |
| | | | | | | MIN TYP(3 |) MAX | MIN | TYP | MAX | • |
| | | | I _{OH} = -100 μA | 0.7 V - 3.6 V | 0.7 V - 3.6 V | V _{CCO} - 0.1 | | V _{CCO} - 0.1 | | | |
| | | | I _{OH} = -50 μA | 0.65 V | 0.65 V | 0.55 | | 0.55 | | | |
| | | | I _{OH} = -200 μA | 0.76 V | 0.76 V | 0.58 | | 0.58 | | | |
| | High-level | | I _{OH} = -500 μA | 0.85 V | 0.85 V | 0.65 | | 0.65 | | | |
| V_{OH} | output voltage | $V_I = V_{IH}$ | I _{OH} = -3 mA | 1.1 V | 1.1 V | 0.85 | | 0.85 | | | V |
| | | | I _{OH} = -6 mA | 1.4 V | 1.4 V | 1.05 | | 1.05 | | | |
| | | | I _{OH} = -8 mA | 1.65 V | 1.65 V | 1.2 | | 1.2 | | | |
| | | | I _{OH} = -9 mA | 2.3 V | 2.3 V | 1.75 | | 1.75 | | | |
| | | | I _{OH} = -12 mA | 3 V | 3 V | 2.3 | | 2.3 | | | |
| | | | I _{OL} = 100 μA | 0.7 V - 3.6 V | 0.7 V - 3.6 V | | 0.1 | | | 0.1 | |
| | | | I _{OL} = 50 μA | 0.65 V | 0.65 V | | 0.1 | | | 0.1 | |
| | | | I _{OL} = 200 μA | 0.76 V | 0.76 V | | 0.18 | | | 0.18 | |
| | Low-level output voltage | | I _{OL} = 500 μA | 0.85 V | 0.85 V | | 0.2 | | | 0.2 | |
| V_{OL} | | $V_I = V_{IL}$ | I _{OL} = 3 mA | 1.1 V | 1.1 V | | 0.25 | | | 0.25 | V |
| | output voltage | | I _{OL} = 6 mA | 1.4 V | 1.4 V | | 0.35 | | | 0.35 | |
| | | | I _{OL} = 8 mA | 1.65 V | 1.65 V | | 0.45 | | | 0.45 | |
| | | | I _{OL} = 9 mA | 2.3 V | 2.3 V | | 0.55 | | | 0.55 | |
| | | | I _{OL} = 12 mA | 3 V | 3 V | | 0.7 | | | 0.7 | |
| | | V _I = 0.20 V | / | 0.65 V | 0.65 V | 4 | | 4 | | | |
| | | V _I = 0.23 \ | / | 0.76 V | 0.76 V | 8 | | 7 | | | |
| | | V _I = 0.26 \ | / | 0.85 V | 0.85 V | 10 | | 10 | | | |
| | Bus-hold low | V _I = 0.39 \ | / | 1.1 V | 1.1 V | 20 | | 20 | | | |
| I _{BHL} | sustaining current (4) | V _I = 0.49 \ | / | 1.4 V | 1.4 V | 40 | | 30 | | | μA |
| | | V _I = 0.58 \ | / | 1.65 V | 1.65 V | 55 | | 45 | | | |
| | | V _I = 0.7 V | | 2.3 V | 2.3 V | 90 | | 80 | | | |
| | | V _I = 0.8 V | | 3 V | 3 V | 145 | | 135 | | | |
| | | V _I = 0.45 \ | / | 0.65 V | 0.65 V | -4 | | -4 | | | |
| | | V _I = 0.53 \ | / | 0.76 V | 0.76 V | -8 | | - 7 | | | |
| | | V _I = 0.59 \ | / | 0.85 V | 0.85 V | -10 | | -10 | | | |
| | Bus-hold high | V _I = 0.71 V | / | 1.1 V | 1.1 V | -20 | | -20 | | | |
| I _{BHH} | sustaining current ⁽⁵⁾ | V _I = 0.91 V | / | 1.4 V | 1.4 V | -40 | | -30 | | | μA |
| | | V _I = 1.07 \ | / | 1.65 V | 1.65 V | -55 | | -45 | | | |
| | | V _I = 1.6 V | | 2.3 V | 2.3 V | -90 | | -80 | | | |
| | | V _I = 2.0 V | | 3 V | 3 V | -145 | | -135 | | | |

6.5 Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted) (1) (2)

| | | | | | | Operatin | g free-air | tempera | ture (T | A) | |
|-------------------------------------|------------------------------------|--|----------------------------------|------------------|------------------|-----------|------------|---------|----------|-----|-----|
| PA | RAMETER | TEST | CONDITIONS | V _{CCA} | V _{CCB} | –40°C to | 85°C | -40°0 | C to 125 | 5°C | UNI |
| | | | | | | MIN TYP(3 |) MAX | MIN | TYP | MAX | • |
| | | | | 0.75 V | 0.75 V | 40 | | 40 | | | |
| | | | | 0.84 V | 0.84 V | 50 | | 50 | | | |
| | | | | 0.95 V | 0.95 V | 65 | | 65 | | | |
| | Bus-hold low | | | 1.3 V | 1.3 V | 105 | | 105 | | | |
| I _{BHLO} | overdrive current (6) | $V_1 = 0$ to V_0 | CC | 1.6 V | 1.6 V | 150 | | 150 | | | μA |
| | | | | 1.95 V | 1.95 V | 205 | | 205 | | | |
| l | | | | 2.7 V | 2.7 V | 335 | | 335 | | | |
| | | | | 3.6 V | 3.6 V | 480 | | 480 | | | |
| | | | | 0.75 V | 0.75 V | -40 | | -40 | | | |
| | | | | 0.84 V | 0.84 V | -50 | | -50 | | | |
| | | | | 0.95 V | 0.95 V | -65 | | -65 | | | |
| ١, | Bus-hold high overdrive | $V_{I} = 0$ to V_{CC} | | 1.3 V | 1.3 V | -105 | | -105 | | | |
| I _{BHHO} | current (7) | | | 1.6 V | 1.6 V | -150 | | -150 | | | μA |
| | | | | 1.95 V | 1.95 V | -205 | | -205 | | | |
| | | | | 2.7 V | 2.7 V | -335 | | -335 | | | |
| | | | | 3.6 V | 3.6 V | -480 | | -480 | | | |
| | Input leakage | Control inp V _{CCA} or GN | ut (DIR): V _I = ND | 0.65 V - 3.6 V | 0.65 V - 3.6 V | -0.5 | 0.5 | -1 | | 1 | |
| l _l | current | A or B Port GND | : Vi = V _{CCI} or | 0.65 V - 3.6 V | 0.65 V - 3.6 V | -4 | 4 | -8 | | 8 | μA |
| | Partial power | A or B Port | : Vi or Vo = 0 V - | 0 V | 0 V - 3.6 V | -8 | 8 | -12 | | 12 | |
| l _{off} | down current | 3.6 V | | 0 V - 3.6 V | 0 V | -8 | 8 | -12 | | 12 | μA |
| | | ., ., | | 0.65 V - 3.6 V | 0.65 V - 3.6 V | | 8 | | | 12 | |
| I_{CCA} | V _{CCA} supply current | V _I = V _{CCI} or GND | I _O = 0 | 0 V | 3.6 V | -2 | | -8 | | | μΑ |
| | | | | 3.6 V | 0 V | | 2 | | | 8 | |
| | | ., ., | | 0.65 V - 3.6 V | 0.65 V - 3.6 V | | 8 | | | 12 | |
| I_{CCB} | V _{CCB} supply current | V _I = V _{CCI} or GND | I _O = 0 | 0 V | 3.6 V | | 2 | | | 8 | μΑ |
| | | | | 3.6 V | 0 V | -2 | | -8 | | | |
| I _{CCA} + I _{CCB} | Combined supply current | V _I = V _{CCI} or GND | I _O = 0 | 0.65 V - 3.6 V | 0.65 V - 3.6 V | | 10 | | | 16 | μA |
| C _i | Control input capacitance | V _I = 3.3 V d | or GND | 3.3 V | 3.3 V | 4.0 | 3 | | 4.3 | | pF |
| C _{io} | Data I/O capacitance, A Port | V _O = 1.65 V DC +1 MHz -16 dBm sine wave | | 3.3 V | 0 V | 7.4 | 4 | | 7.4 | | pF |
| C _{io} | Data I/O capacitance, B Port | V _O = 1.65 V dBm sine v | / DC +1 MHz -16 vave | 0 V | 3.3 V | 7.4 | 4 | | 7.4 | | pF |

- (1) VCCI is the VCC associated with the input port.
- (2) VCCO is the VCC associated with the output port.
- (3) All typical data is taken at 25°C.
- (4) The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL}(MAX). I_{BHL} should be measured after lowering V_I to GND and then raising it to V_{IL}(MAX).
- (5) The bus-hold circuit can source at least the minimum high sustaining current at $V_{IH}(MIN)$. I_{BHH} should be measured after raising V_I to V_{CC} and then lowering it to $V_{IH}(MIN)$.
- (6) An external driver must source at least I_{BHLO} to switch this node from low to high.
- (7) An external driver must sink at least I_{BHHO} to switch this node from high to low.



6.6 Switching Characteristics, $V_{CCA} = 0.7 \text{ V}$

| | | | | | | | | | | | B-Port | Supply | Voltage (V | св) | | | | | | | | | | | | | | | | | | | | |
|--------------------|---------------------------------|-------------|-----|-----------------|-----------|------|-----------|------|----------------|----------------|---------|--------|----------------|------|----------|-------|----------------|------|---------|------|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| PA | ARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 |)5 V | 0.8 ± 0.0 | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | .1 V | 1.5 ± 0 | .1 V | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT | | | | | | | | | | | | | |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | | | | | | | |
| | | Α | В | -40°C to 85°C | 0.5 | 181 | 0.5 | 119 | 0.5 | 85 | 0.5 | 51 | 0.5 | 49 | 0.5 | 52 | 0.5 | 65 | 0.5 | 152 | | | | | | | | | | | | | | |
| + . D | Propagation delay | ^ | | -40°C to 125°C | 0.5 | 181 | 0.5 | 119 | 0.5 | 85 | 0.5 | 51 | 0.5 | 49 | 0.5 | 52 | 0.5 | 65 | 0.5 | 152 | ns | | | | | | | | | | | | | |
| t _{pd} Pi | Topagation delay | В | Α | –40°C to 85°C | 0.5 | 181 | 0.5 | 162 | 0.5 | 136 | 0.5 | 96 | 0.5 | 91 | 0.5 | 89 | 0.5 | 88 | 0.5 | 88 | 115 | | | | | | | | | | | | | |
| | | ь | _ ^ | -40°C to 125°C | 0.5 | 181 | 0.5 | 162 | 0.5 | 136 | 0.5 | 96 | 0.5 | 91 | 0.5 | 89 | 0.5 | 88 | 0.5 | 88 | | | | | | | | | | | | | | |
| | | DIR | | -40°C to 85°C | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | | | | | | | | | | | | | | |
| , n | Disable time | DIR | DIK | DIK | DIIX | DIK | DIK | A | -40°C to 125°C | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | 0.5 | 152 | ns | | | | | | | | |
| t _{dis} D | isable time | DID | B | –40°C to 85°C | 0.5 | 170 | 0.5 | 127 | 0.5 | 102 | 0.5 | 48 | 0.5 | 42 | 0.5 | 46 | 0.5 | 58 | 0.5 | 108 | 115 | | | | | | | | | | | | | |
| | | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR B | -40°C to 125°C | 0.5 | 170 | 0.5 | 127 | 0.5 | 102 | 0.5 | 48 | 0.5 | 42 | 0.5 | 46 | 0.5 | 58 | 0.5 | 108 | | | | | |
| | | DIB | ۸ | -40°C to 85°C | 0.5 | 343 | 0.5 | 278 | 0.5 | 231 | 0.5 | 141 | 0.5 | 132 | 0.5 | 134 | 0.5 | 144 | 0.5 | 193 | | | | | | | | | | | | | | |
| , = | t _{en} Enable time DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR A | -40°C to 125°C | 0.5 | 343 | 0.5 | 278 | 0.5 | 231 | 0.5 | 141 | 0.5 | 132 | 0.5 | 134 | 0.5 | 144 | 0.5 | 193 | 200 |
| len E | | Enable time | DIR | DIR | DIR | DIR | DIR | В | -40°C to 85°C | 0.5 | 326 | 0.5 | 257 | 0.5 | 222 | 0.5 | 194 | 0.5 | 191 | 0.5 | 191 | 0.5 | 197 | 0.5 | 277 | ns | | | | | | | | |
| | | DIR | | | | | | DIR | | -40°C to 125°C | 0.5 | 326 | 0.5 | 257 | 0.5 | 222 | 0.5 | 194 | 0.5 | 191 | 0.5 | 191 | 0.5 | 197 | 0.5 | 277 | | | | | | | | |

6.7 Switching Characteristics, V_{CCA} = 0.8 V

| | | | | | | | | | | B-Port | Supply | Voltage (V | ссв) | | | | | | | | | | | | | | | |
|-----------------------------------|-------|-------|-----------------|----------------|---------------|-----------|------|-----------|----------------|---------|---------------|------------|------|----------|------|---------|------|---------|------|------|-----|-----|-----|-----|-----|-----|----|-----|
| PARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 |)5 V | 0.8 ± 0.0 | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | .1 V | 1.5 ± 0 | .1 V | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT | | | | | | | | |
| | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | | |
| | A | В | -40°C to 85°C | 0.5 | 162 | 0.5 | 98 | 0.5 | 65 | 0.5 | 33 | 0.5 | 28 | 0.5 | 26 | 0.5 | 27 | 0.5 | 37 | | | | | | | | | |
| t _{nd} Propagation delay | _ ^ | | -40°C to 125°C | 0.5 | 162 | 0.5 | 98 | 0.5 | 65 | 0.5 | 33 | 0.5 | 28 | 0.5 | 26 | 0.5 | 27 | 0.5 | 37 | | | | | | | | | |
| t _{pd} Propagation delay | В | А | -40°C to 85°C | 0.5 | 119 | 0.5 | 98 | 0.5 | 81 | 0.5 | 54 | 0.5 | 45 | 0.5 | 44 | 0.5 | 43 | 0.5 | 42 | ns | | | | | | | | |
| | | _ ^ | -40°C to 125°C | 0.5 | 119 | 0.5 | 98 | 0.5 | 81 | 0.5 | 54 | 0.5 | 45 | 0.5 | 44 | 0.5 | 43 | 0.5 | 42 | | | | | | | | | |
| | DIR A | DIR | DIR | _ | -40°C to 85°C | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | | | | | | | |
| t _{rlis} Disable time | | DIR A | DIIX X | -40°C to 125°C | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | 0.5 | 107 | ns | | | | | | | |
| t _{dis} Disable time | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR | DIR B | -40°C to 85°C | 0.5 | 160 | 0.5 | 117 | 0.5 | 90 | 0.5 | 39 | 0.5 | 31 | 0.5 | 29 | 0.5 | 29 | 0.5 | 37 | 115 |
| | | | | | | | | | -40°C to 125°C | 0.5 | 160 | 0.5 | 117 | 0.5 | 90 | 0.5 | 39 | 0.5 | 31 | 0.5 | 29 | 0.5 | 29 | 0.5 | 37 | | | |
| | DIR | A | -40°C to 85°C | 0.5 | 268 | 0.5 | 205 | 0.5 | 165 | 0.5 | 90 | 0.5 | 74 | 0.5 | 71 | 0.5 | 70 | 0.5 | 77 | | | | | | | | | |
| t Enable time | DIIX | _ ^ | -40°C to 125°C | 0.5 | 268 | 0.5 | 205 | 0.5 | 165 | 0.5 | 90 | 0.5 | 74 | 0.5 | 71 | 0.5 | 70 | 0.5 | 77 | ns | | | | | | | | |
| en Enable time — | DIR | DIR | DIR | DIR | DIR | DIP | DIP | DID B | -40°C to 85°C | 0.5 | 257 | 0.5 | 194 | 0.5 | 161 | 0.5 | 130 | 0.5 | 125 | 0.5 | 126 | 0.5 | 125 | 0.5 | 132 | 113 | | |
| | DIIX | DIR B | -40°C to 125°C | 0.5 | 257 | 0.5 | 194 | 0.5 | 161 | 0.5 | 130 | 0.5 | 125 | 0.5 | 126 | 0.5 | 125 | 0.5 | 132 | | | | | | | | | |

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6.8 Switching Characteristics, V_{CCA} = 0.9 V

| | | | | | | | | | | | B-Port | Supply | Voltage (V | ссв) | | | | | | | |
|------------------|-------------------|------|-----|-----------------|-----------|------|-----------|------|-----------|------|---------|--------|------------|------|----------|------|---------|------|---------|------|------|
| | PARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 |)5 V | 0.8 ± 0.0 | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | .1 V | 1.5 ± 0 | .1 V | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | Α | В | -40°C to 85°C | 0.5 | 135 | 0.5 | 81 | 0.5 | 54 | 0.5 | 24 | 0.5 | 18 | 0.5 | 17 | 0.5 | 15 | 0.5 | 18 | |
| | Propagation delay | ^ | | -40°C to 125°C | 0.5 | 135 | 0.5 | 81 | 0.5 | 54 | 0.5 | 24 | 0.5 | 18 | 0.5 | 17 | 0.5 | 15 | 0.5 | 18 | ns |
| t _{pd} | Propagation delay | В | А | -40°C to 85°C | 0.5 | 86 | 0.5 | 65 | 0.5 | 54 | 0.5 | 41 | 0.5 | 30 | 0.5 | 26 | 0.5 | 23 | 0.5 | 23 | |
| | | ь | _ ^ | -40°C to 125°C | 0.5 | 86 | 0.5 | 65 | 0.5 | 54 | 0.5 | 41 | 0.5 | 30 | 0.5 | 26 | 0.5 | 23 | 0.5 | 23 | . |
| | | DIR | Α | -40°C to 85°C | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | |
| | Disable time | DIK | _ ^ | -40°C to 125°C | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | 0.5 | 79 | ns |
| ^I dis | Disable time | DIR | В | –40°C to 85°C | 0.5 | 154 | 0.5 | 111 | 0.5 | 85 | 0.5 | 34 | 0.5 | 27 | 0.5 | 25 | 0.5 | 21 | 0.5 | 23 | |
| | | DIIX | Ь | -40°C to 125°C | 0.5 | 154 | 0.5 | 111 | 0.5 | 85 | 0.5 | 34 | 0.5 | 27 | 0.5 | 25 | 0.5 | 21 | 0.5 | 23 | |
| | | DIR | A | –40°C to 85°C | 0.5 | 227 | 0.5 | 166 | 0.5 | 131 | 0.5 | 71 | 0.5 | 53 | 0.5 | 48 | 0.5 | 42 | 0.5 | 44 | |
| | Enable time | DIIX | _ ^ | -40°C to 125°C | 0.5 | 227 | 0.5 | 166 | 0.5 | 131 | 0.5 | 71 | 0.5 | 53 | 0.5 | 48 | 0.5 | 42 | 0.5 | 44 | ns |
| t _{en} | Enable time | DIR | В | -40°C to 85°C | 0.5 | 206 | 0.5 | 152 | 0.5 | 125 | 0.5 | 96 | 0.5 | 91 | 0.5 | 89 | 0.5 | 89 | 0.5 | 92 | 115 |
| | | DIIX | | –40°C to 125°C | 0.5 | 206 | 0.5 | 152 | 0.5 | 125 | 0.5 | 96 | 0.5 | 91 | 0.5 | 89 | 0.5 | 89 | 0.5 | 92 | |

6.9 Switching Characteristics, V_{CCA} = 1.2 V

| | | | | | | | | | | B-Port | Supply | Voltage (V | CCB) | | | | | | | |
|-----------------------------------|------|-----|-----------------|-----------|------|----------|------|-----------|------|---------|--------|------------|------|----------|------|---------|------|---------|------|------|
| PARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 |)5 V | 0.8 ± 0. | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | .1 V | 1.5 ± 0 | .1 V | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT |
| | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | A | В | -40°C to 85°C | 0.5 | 95 | 0.5 | 54 | 0.5 | 41 | 0.5 | 16 | 0.5 | 11 | 0.5 | 9 | 0.5 | 8 | 0.5 | 8 | |
| t _{pd} Propagation delay | ^ | | -40°C to 125°C | 0.5 | 95 | 0.5 | 54 | 0.5 | 41 | 0.5 | 16 | 0.5 | 11 | 0.5 | 9 | 0.5 | 8 | 0.5 | 8 | no |
| t _{pd} Propagation delay | В | А | -40°C to 85°C | 0.5 | 51 | 0.5 | 33 | 0.5 | 24 | 0.5 | 16 | 0.5 | 13 | 0.5 | 11 | 0.5 | 8 | 0.5 | 8 | ns |
| | | _ ^ | -40°C to 125°C | 0.5 | 51 | 0.5 | 33 | 0.5 | 24 | 0.5 | 16 | 0.5 | 13 | 0.5 | 11 | 0.5 | 8 | 0.5 | 8 | l |
| | DIR | A | -40°C to 85°C | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | |
| t _{dis} Disable time | Diix | _ ^ | -40°C to 125°C | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | ns |
| t _{dis} Disable time | DIR | В | -40°C to 85°C | 0.5 | 148 | 0.5 | 105 | 0.5 | 78 | 0.5 | 30 | 0.5 | 23 | 0.5 | 20 | 0.5 | 16 | 0.5 | 16 | 115 |
| | DIK | | -40°C to 125°C | 0.5 | 148 | 0.5 | 105 | 0.5 | 78 | 0.5 | 30 | 0.5 | 23 | 0.5 | 20 | 0.5 | 16 | 0.5 | 16 | l |
| | DIR | A | -40°C to 85°C | 0.5 | 191 | 0.5 | 129 | 0.5 | 96 | 0.5 | 43 | 0.5 | 34 | 0.5 | 30 | 0.5 | 23 | 0.5 | 22 | |
| t _{en} Enable time | DIK | _ ^ | -40°C to 125°C | 0.5 | 191 | 0.5 | 129 | 0.5 | 96 | 0.5 | 43 | 0.5 | 34 | 0.5 | 30 | 0.5 | 23 | 0.5 | 22 | ns |
| t _{en} Enable time | DIP | В | -40°C to 85°C | 0.5 | 116 | 0.5 | 75 | 0.5 | 61 | 0.5 | 41 | 0.5 | 37 | 0.5 | 36 | 0.5 | 35 | 0.5 | 35 | |
| | DIR | | -40°C to 125°C | 0.5 | 116 | 0.5 | 75 | 0.5 | 61 | 0.5 | 41 | 0.5 | 37 | 0.5 | 36 | 0.5 | 35 | 0.5 | 35 | 1 |

10



6.10 Switching Characteristics, $V_{CCA} = 1.5 V$

| | | | | | | | | | | B-Port | Supply | Voltage (V | ссв) | | | | | | | |
|-----------------------------------|------|----|-----------------|-----------|------|-----------|------|-----------|------|---------|--------|------------|------|----------|------|---------|------|---------|------|------|
| PARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 |)5 V | 0.8 ± 0.0 | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | .1 V | 1.5 ± 0 | .1 V | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT |
| | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | –40°C to 85°C | 0.5 | 91 | 0.5 | 45 | 0.5 | 30 | 0.5 | 13 | 0.5 | 9 | 0.5 | 8 | 0.5 | 6 | 0.5 | 6 | |
| t _{pd} Propagation delay | _ ^ | | -40°C to 125°C | 0.5 | 91 | 0.5 | 45 | 0.5 | 30 | 0.5 | 13 | 0.5 | 9 | 0.5 | 8 | 0.5 | 6 | 0.5 | 6 | ns |
| t _{pd} Propagation delay | В | _ | -40°C to 85°C | 0.5 | 49 | 0.5 | 28 | 0.5 | 18 | 0.5 | 11 | 0.5 | 9 | 0.5 | 8 | 0.5 | 6 | 0.5 | 5 | 115 |
| | В | A | -40°C to 125°C | 0.5 | 49 | 0.5 | 28 | 0.5 | 18 | 0.5 | 11 | 0.5 | 9 | 0.5 | 8 | 0.5 | 6 | 0.5 | 5 | |
| | DIR | _ | -40°C to 85°C | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | |
| t _{dis} Disable time | DIK | A | -40°C to 125°C | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | 0.5 | 20 | ns |
| t _{dis} Disable time | DIR | В | –40°C to 85°C | 0.5 | 146 | 0.5 | 103 | 0.5 | 76 | 0.5 | 28 | 0.5 | 21 | 0.5 | 19 | 0.5 | 15 | 0.5 | 14 | 115 |
| | DIK | | -40°C to 125°C | 0.5 | 146 | 0.5 | 103 | 0.5 | 76 | 0.5 | 28 | 0.5 | 21 | 0.5 | 19 | 0.5 | 15 | 0.5 | 14 | |
| | DIR | Α | -40°C to 85°C | 0.5 | 186 | 0.5 | 124 | 0.5 | 89 | 0.5 | 38 | 0.5 | 29 | 0.5 | 26 | 0.5 | 20 | 0.5 | 18 | |
| t _{en} Enable time | DIK | ^ | -40°C to 125°C | 0.5 | 186 | 0.5 | 124 | 0.5 | 89 | 0.5 | 38 | 0.5 | 29 | 0.5 | 26 | 0.5 | 20 | 0.5 | 18 | no |
| t _{en} Enable time | DID | В | -40°C to 85°C | 0.5 | 104 | 0.5 | 58 | 0.5 | 43 | 0.5 | 31 | 0.5 | 28 | 0.5 | 27 | 0.5 | 25 | 0.5 | 25 | ns |
| | | | -40°C to 125°C | 0.5 | 104 | 0.5 | 58 | 0.5 | 43 | 0.5 | 31 | 0.5 | 28 | 0.5 | 27 | 0.5 | 25 | 0.5 | 25 | |

6.11 Switching Characteristics, V_{CCA} = 1.8 V

| | | | 7 004 | | | | | | | B-Port | Supply | Voltage (V | ссв) | | | | | | | |
|-----------------------------------|------|-----|-----------------|-----------|------|-----------|------|-----------|------|---------|--------|------------|------|----------|------|---------|------|---------|------|------|
| PARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 |)5 V | 0.8 ± 0.0 | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | .1 V | 1.5 ± 0 | .1 V | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT |
| | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | -40°C to 85°C | 0.5 | 89 | 0.5 | 44 | 0.5 | 26 | 0.5 | 11 | 0.5 | 8 | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | |
| t _{pd} Propagation delay | _ ^ | В | -40°C to 125°C | 0.5 | 89 | 0.5 | 44 | 0.5 | 26 | 0.5 | 11 | 0.5 | 8 | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | no |
| t _{pd} Propagation delay | В | А | -40°C to 85°C | 0.5 | 52 | 0.5 | 26 | 0.5 | 17 | 0.5 | 9 | 0.5 | 8 | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | ns |
| | | _ ^ | -40°C to 125°C | 0.5 | 52 | 0.5 | 26 | 0.5 | 17 | 0.5 | 9 | 0.5 | 8 | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | |
| | DIR | А | -40°C to 85°C | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | |
| t _{die} Disable time | DIK | _ ^ | -40°C to 125°C | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | ns |
| t _{dis} Disable time | DIR | В | -40°C to 85°C | 0.5 | 147 | 0.5 | 103 | 0.5 | 76 | 0.5 | 27 | 0.5 | 20 | 0.5 | 18 | 0.5 | 14 | 0.5 | 13 | 115 |
| | DIK | В | -40°C to 125°C | 0.5 | 147 | 0.5 | 103 | 0.5 | 76 | 0.5 | 27 | 0.5 | 20 | 0.5 | 18 | 0.5 | 14 | 0.5 | 13 | |
| | DIR | А | -40°C to 85°C | 0.5 | 185 | 0.5 | 122 | 0.5 | 86 | 0.5 | 35 | 0.5 | 27 | 0.5 | 24 | 0.5 | 19 | 0.5 | 17 | |
| t _{en} Enable time | DIK | A | -40°C to 125°C | 0.5 | 185 | 0.5 | 122 | 0.5 | 86 | 0.5 | 35 | 0.5 | 27 | 0.5 | 24 | 0.5 | 19 | 0.5 | 17 | 200 |
| t _{en} Enable time | DIR | В | -40°C to 85°C | 0.5 | 100 | 0.5 | 54 | 0.5 | 37 | 0.5 | 27 | 0.5 | 25 | 0.5 | 24 | 0.5 | 22 | 0.5 | 22 | ns |
| | DIK | В | -40°C to 125°C | 0.5 | 100 | 0.5 | 54 | 0.5 | 37 | 0.5 | 27 | 0.5 | 25 | 0.5 | 24 | 0.5 | 22 | 0.5 | 22 | |

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6.12 Switching Characteristics, $V_{CCA} = 2.5 \text{ V}$

| | | | | | | | | | | B-Port | Supply | Voltage (V | ссв) | | | | | | | |
|-----------------------------------|------|-----|-----------------|-----------|------|-----------|------|-----------|------|---------|--------|------------|------|----------|------|---------|------|---------|------|------|
| PARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 | 05 V | 0.8 ± 0.0 | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | .1 V | 1.5 ± 0 | .1 V | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT |
| | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | -40°C to 85°C | 0.5 | 88 | 0.5 | 42 | 0.5 | 23 | 0.5 | 8 | 0.5 | 6 | 0.5 | 6 | 0.5 | 5 | 0.5 | 5 | |
| t _{pd} Propagation delay | _ ^ | | -40°C to 125°C | 0.5 | 88 | 0.5 | 42 | 0.5 | 23 | 0.5 | 8 | 0.5 | 6 | 0.5 | 6 | 0.5 | 5 | 0.5 | 5 | ns |
| t _{pd} Propagation delay | В | _ | -40°C to 85°C | 0.5 | 65 | 0.5 | 27 | 0.5 | 15 | 0.5 | 8 | 0.5 | 6 | 0.5 | 6 | 0.5 | 5 | 0.5 | 4 | 115 |
| | _ B | A | -40°C to 125°C | 0.5 | 65 | 0.5 | 27 | 0.5 | 15 | 0.5 | 8 | 0.5 | 6 | 0.5 | 6 | 0.5 | 5 | 0.5 | 4 | 1 |
| | DIR | А | -40°C to 85°C | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | |
| t _{dia} Disable time | DIK | _ ^ | -40°C to 125°C | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | 0.5 | 13 | ns |
| t _{dis} Disable time | DIR | В | -40°C to 85°C | 0.5 | 146 | 0.5 | 102 | 0.5 | 75 | 0.5 | 27 | 0.5 | 19 | 0.5 | 17 | 0.5 | 13 | 0.5 | 12 | 115 |
| | DIK | В | -40°C to 125°C | 0.5 | 146 | 0.5 | 102 | 0.5 | 75 | 0.5 | 27 | 0.5 | 19 | 0.5 | 17 | 0.5 | 13 | 0.5 | 12 | 1 |
| | DIR | А | -40°C to 85°C | 0.5 | 191 | 0.5 | 122 | 0.5 | 85 | 0.5 | 33 | 0.5 | 25 | 0.5 | 22 | 0.5 | 17 | 0.5 | 16 | |
| t _{en} Enable time | DIK | _ ^ | -40°C to 125°C | 0.5 | 191 | 0.5 | 122 | 0.5 | 85 | 0.5 | 33 | 0.5 | 25 | 0.5 | 22 | 0.5 | 17 | 0.5 | 16 | |
| t _{en} Enable time | DIR | В | -40°C to 85°C | 0.5 | 95 | 0.5 | 50 | 0.5 | 31 | 0.5 | 20 | 0.5 | 18 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | ns |
| | DIK | | -40°C to 125°C | 0.5 | 95 | 0.5 | 50 | 0.5 | 31 | 0.5 | 20 | 0.5 | 18 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 1 |

6.13 Switching Characteristics, V_{CCA} = 3.3 V

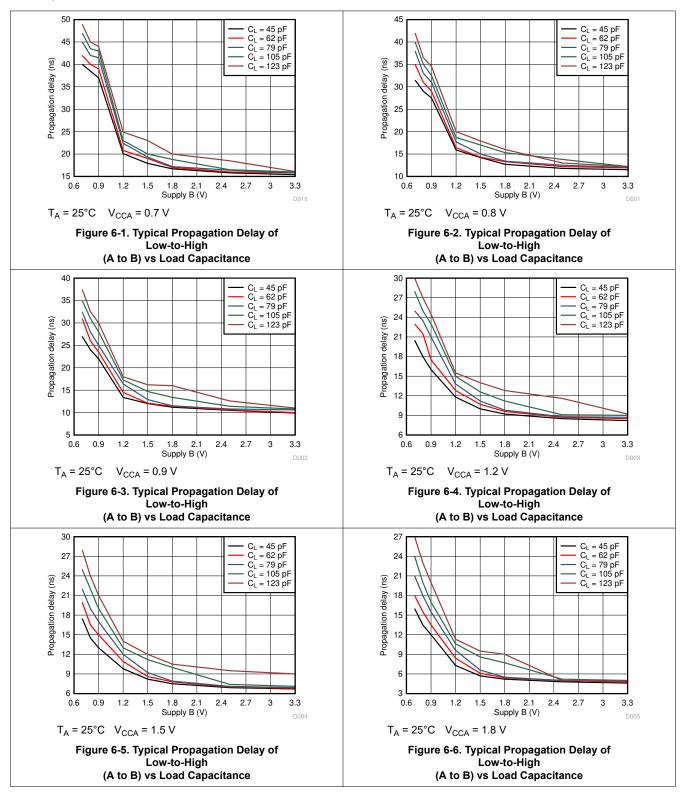
| | | | | , , , , , , , , , , , , , , , , , , , | | | | | | | R-Port | Supply | Voltage (V | 1 | | | | | | | |
|--------------------|-------------------|------|-----|---|-----------|------|-----------|------|-----------|------|---------|--------|------------|-----|----------|------|---------|------|---------|------|------|
| | PARAMETER | FROM | то | Test Conditions | 0.7 ± 0.0 | 15 V | 0.8 ± 0.0 | 04 V | 0.9 ± 0.0 | 45 V | 1.2 ± 0 | | 1.5 ± 0 | | 1.8 ± 0. | 15 V | 2.5 ± 0 | .2 V | 3.3 ± 0 | .3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | ^ | В | -40°C to 85°C | 0.5 | 87 | 0.5 | 42 | 0.5 | 23 | 0.5 | 8 | 0.5 | 5 | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | |
| ١ | Duamanatian dalau | Α | В | –40°C to 125°C | 0.5 | 87 | 0.5 | 42 | 0.5 | 23 | 0.5 | 8 | 0.5 | 5 | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | |
| t _{pd} I | Propagation delay | В | _ | –40°C to 85°C | 0.5 | 154 | 0.5 | 37 | 0.5 | 18 | 0.5 | 8 | 0.5 | 6 | 0.5 | 5 | 0.5 | 5 | 0.5 | 4 | ns |
| | | ь | A | -40°C to 125°C | 0.5 | 154 | 0.5 | 37 | 0.5 | 18 | 0.5 | 8 | 0.5 | 6 | 0.5 | 5 | 0.5 | 5 | 0.5 | 4 | |
| | | DIR | А | –40°C to 85°C | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | |
| | Disable time | DIIX | _ ^ | –40°C to 125°C | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | ns |
| t _{dis} I | Disable time | DIR | В | –40°C to 85°C | 0.5 | 147 | 0.5 | 102 | 0.5 | 75 | 0.5 | 26 | 0.5 | 19 | 0.5 | 17 | 0.5 | 13 | 0.5 | 12 | 115 |
| | | DIIX | Ь | –40°C to 125°C | 0.5 | 147 | 0.5 | 102 | 0.5 | 75 | 0.5 | 26 | 0.5 | 19 | 0.5 | 17 | 0.5 | 13 | 0.5 | 12 | |
| | | DIR | A | –40°C to 85°C | 0.5 | 275 | 0.5 | 129 | 0.5 | 88 | 0.5 | 34 | 0.5 | 24 | 0.5 | 21 | 0.5 | 17 | 0.5 | 16 | |
| | Enable time | DIIX | _ ^ | –40°C to 125°C | 0.5 | 275 | 0.5 | 129 | 0.5 | 88 | 0.5 | 34 | 0.5 | 24 | 0.5 | 21 | 0.5 | 17 | 0.5 | 16 | ns |
| t _{en} i | Litable time | DIR | В | –40°C to 85°C | 0.5 | 94 | 0.5 | 49 | 0.5 | 30 | 0.5 | 18 | 0.5 | 16 | 0.5 | 16 | 0.5 | 15 | 0.5 | 15 | 113 |
| | | DIIX | | –40°C to 125°C | 0.5 | 94 | 0.5 | 49 | 0.5 | 30 | 0.5 | 18 | 0.5 | 16 | 0.5 | 16 | 0.5 | 15 | 0.5 | 15 | |



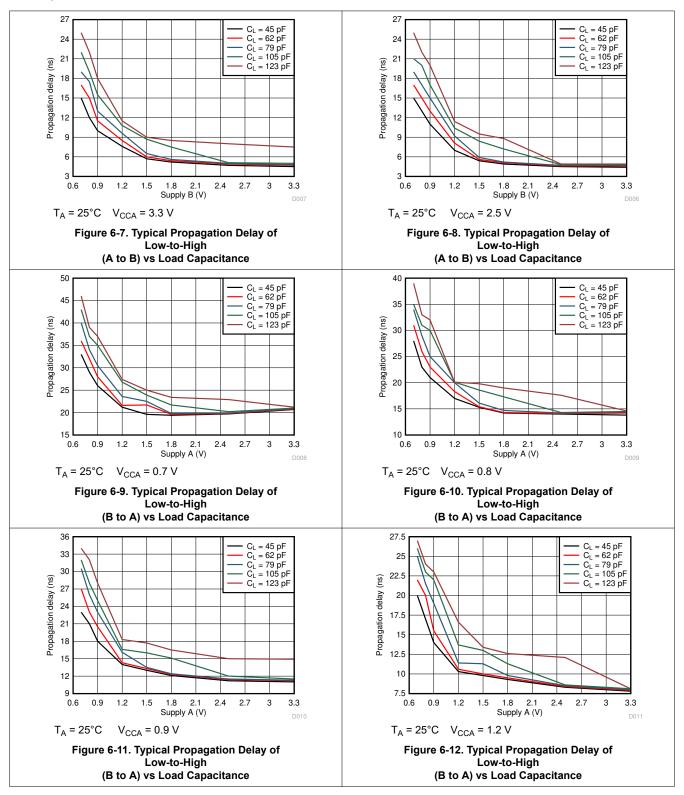
6.14 Operating Characteristics: $T_A = 25$ °C

| | PARAMETER | TEST CONDITIONS | V _{CCA} | V _{CCB} | MIN TYP | MAX | UNIT |
|------------------|--|-------------------------|------------------|------------------|---------|-----|------|
| | | | 0.7 V | 0.7 V | 2.0 | | |
| | | | 0.8 V | 0.8 V | 2.0 | | |
| | | | 0.9 V | 0.9 V | 2.0 | | |
| | Power Dissipation Capacitance | CL = 0, RL = Open f = 1 | 1.2 V | 1.2 V | 2.0 | | "_ |
| | per transceiver (A to B: outputs enabled) | MHz, tr = tf = 1 ns | 1.5 V | 1.5 V | 1.9 | | pF |
| | | | 1.8 V | 1.8 V | 2.0 | | |
| | | | 2.5 V | 2.5 V | 2.4 | | |
| | | | 3.3 V | 3.3 V | 3.0 | | |
| C _{pdA} | | | 0.7 V | 0.7 V | 12 | | |
| | | | 0.8 V | 0.8 V | 12 | | |
| | | | 0.9 V | 0.9 V | 12 | | |
| | Power Dissipation Capacitance per transceiver (B to A: outputs | CL = 0, RL = Open f = 1 | 1.2 V | 1.2 V | 12 | | "_ |
| | enabled) | MHz, tr = tf = 1 ns | 1.5 V | 1.5 V | 13 | | pF |
| | , | | 1.8 V | 1.8 V | 13 | | |
| | | | 2.5 V | 2.5 V | 17 | | |
| | | | 3.3 V | 3.3 V | 21 | | |
| | | | 0.7 V | 0.7 V | 12 | | |
| | | | 0.8 V | 0.8 V | 12 | | |
| | | | 0.9 V | 0.9 V | 12 | | |
| | Power Dissipation Capacitance per transceiver (A to B: outputs | CL = 0, RL = Open f = 1 | 1.2 V | 1.2 V | 12 | | pF |
| | enabled) | MHz, tr = tf = 1 ns | 1.5 V | 1.5 V | 13 | | РΓ |
| | | | 1.8 V | 1.8 V | 13 | | |
| | | | 2.5 V | 2.5 V | 17 | | |
| C | | | 3.3 V | 3.3 V | 21 | | |
| C _{pdB} | | | 0.7 V | 0.7 V | 2.1 | | |
| | | | 0.8 V | 0.8 V | 2.2 | | |
| | | | 0.9 V | 0.9 V | 2.2 | | |
| | Power Dissipation Capacitance per transceiver (B to A: outputs | CL = 0, RL = Open f = 1 | 1.2 V | 1.2 V | 2.2 | | pF |
| | enabled) | MHz, tr = tf = 1 ns | 1.5 V | 1.5 V | 2.3 | | ρı |
| | | | 1.8 V | 1.8 V | 2.3 | | |
| | | | 2.5 V | 2.5 V | 2.6 | | |
| | | | 3.3 V | 3.3 V | 3.3 | | |

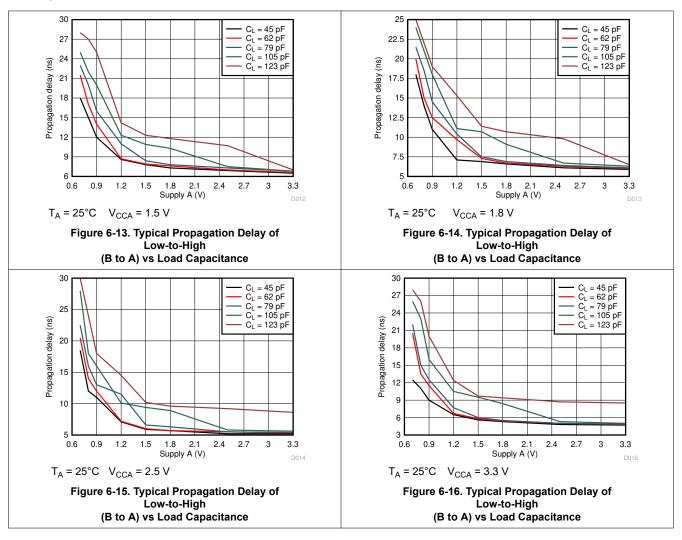
6.15 Typical Characteristics



6.15 Typical Characteristics (continued)



6.15 Typical Characteristics (continued)



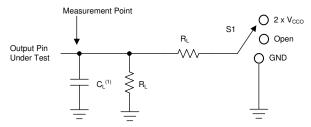


7 Parameter Measurement Information

7.1 Load Circuit and Voltage Waveforms

Unless otherwise noted, all input pulses are supplied by generators having the following characteristics:

- f = 1 MHz
- $Z_{O} = 50 \Omega$
- dv/dt ≤ 1 ns/V

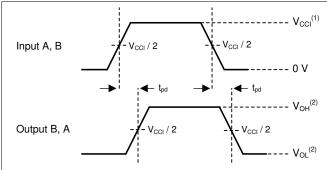


A. C_L includes probe and jig capacitance.

Figure 7-1. Load Circuit

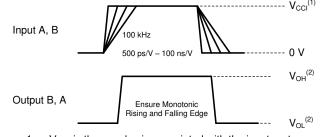
Table 7-1. Load Circuit Conditions

| | Parameter | V _{cco} | R_L | CL | S ₁ | V _{TP} |
|------------------------------------|------------------------------------|--------------------|-------|-------|----------------------|-----------------|
| Δt/Δν | Input transition rise or fall rate | 0.65 V – 3.6 V | 1 ΜΩ | 15 pF | Open | N/A |
| | | 1.1 V – 3.6 V | 2 kΩ | 15 pF | Open | N/A |
| t _{pd} | Propagation (delay) time | 0.65 V - 0.95 V | 20 kΩ | 15 pF | Open | N/A |
| | | 3 V – 3.6 V | 2 kΩ | 15 pF | 2 × V _{CCO} | 0.3 V |
| | | 1.65 V – 2.7 V | 2 kΩ | 15 pF | 2 × V _{CCO} | 0.15 V |
| t _{en} , t _{dis} | Enable time, disable time | 1.1 V – 1.6 V | 2 kΩ | 15 pF | 2 × V _{CCO} | 0.1 V |
| | | 0.65 V – 0.95 V | 20 kΩ | 15 pF | 2 × V _{CCO} | 0.1 V |
| | | 3 V – 3.6 V | 2 kΩ | 15 pF | GND | 0.3 V |
| | | 1.65 V – 2.7 V | 2 kΩ | 15 pF | GND | 0.15 V |
| t _{en} , t _{dis} | Enable time, disable time | 1.1 V – 1.6 V | 2 kΩ | 15 pF | GND | 0.1 V |
| | | 0.65 V – 0.95 V | 20 kΩ | 15 pF | GND | 0.1 V |



- 1. V_{CCI} is the supply pin associated with the input port.
- 2. V_{OH} and V_{OL} are typical output voltage levels that occur with specified R_L , C_L , and S_1

Figure 7-2. Propagation Delay



- 1. V_{CCI} is the supply pin associated with the input port.
- 2. V_{OH} and V_{OL} are typical output voltage levels that occur with specified R_L , C_L , and S_1

Figure 7-3. Input Transition Rise or Fall Rate

DIR $V_{CCA}/2$ $V_{CCA}/2$ $V_{CCA}/2$ $V_{CCA}/2$ $V_{CCA}/2$ $V_{CCA}/2$ $V_{CCO}/6$ $V_{CCO}/2$ $V_{CCO}/2$

- 1. Illustrative purposes only. Enable Time is a calculation as described in the data sheet.
- 2. Output waveform on the condition that input is driven to a valid Logic Low.
- 3. Output waveform on the condition that input is driven to a valid Logic High.
- 4. V_{CCI} is the supply pin associated with the input port
- 5. V_{CCO} is the supply pin associated with the output port.
- 6. V_{OH} and V_{OL} are typical output voltage levels that occur with specified R_L , C_L , and S_1

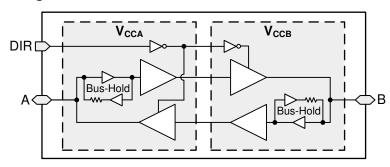
Figure 7-4. Disable and Enable Time

8 Detailed Description

8.1 Overview

The SN74AXCH1T45 is single-bit, dual-supply, noninverting voltage level translator. Pin A and the direction control pin are referenced to V_{CCA} logic levels and pin B is referenced to V_{CCB} logic levels, as depicted in . The A port can accept I/O voltages ranging from 0.65 V to 3.6 V, and the B port can accept I/O voltages from 0.65 V to 3.6 V. A logic high on the DIR pin enables data transmission from A to B and a logic low on the DIR pin enables data transmission from B to A.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Standard CMOS Inputs

Standard CMOS inputs are high impedance and are typically modeled as a resistor in parallel with the input capacitance given in the *Electrical Characteristics*. The worst case resistance is calculated with the maximum input voltage, given in the *Absolute Maximum Ratings*, and the maximum input leakage current, given in the *Electrical Characteristics*, using ohm's law $(R = V \div I)$.

Signals applied to the inputs need to have fast edge rates, as defined by $\Delta t/\Delta v$ in *Recommended Operating Conditions* to avoid excessive current consumption and oscillations. If a slow or noisy input signal is required, a device with a Schmitt-trigger input should be used to condition the input signal prior to the standard CMOS input.

8.3.2 Balanced High-Drive CMOS Push-Pull Outputs

A balanced output allows the device to sink and source similar currents. The high drive capability of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. The electrical and thermal limits defined in the *Absolute Maximum Ratings* must be followed at all times.

8.3.3 Partial Power Down (Ioff)

The inputs and outputs for this device enter a high-impedance state when the device is powered down, inhibiting current backflow into the device. The maximum leakage into or out of any input or output pin on the device is specified by I_{off} in the *Electrical Characteristics*.

8.3.4 V_{CC} Isolation

The inputs and outputs for this device enter a high-impedance state when either supply is <100mV.

8.3.5 Over-Voltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage so long as they remain below the maximum input voltage value specified in the *Recommended Operating Conditions*.

8.3.6 Negative Clamping Diodes

The inputs and outputs to this device have negative clamping diodes as depicted in Figure 8-1.

CAUTION

Voltages beyond the values specified in the Absolute Maximum Ratings table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

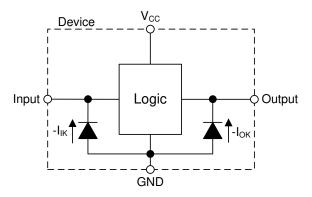


Figure 8-1. Electrical Placement of Clamping Diodes for Each Input and Output

8.3.7 Fully Configurable Dual-Rail Design

Both the V_{CCA} and V_{CCB} pins can be supplied at any voltage from 0.65 V to 3.6 V, making the device suitable for translating between any of the voltage nodes (0.7 V, 0.8 V, 0.9 V, 1.2 V, 1.8 V, 2.5 V and 3.3 V).

8.3.8 Supports High-Speed Translation

The SN74AXCH1T45 device can support high data-rate applications. The translated signal data rate can be up to 500 Mbps when the signal is translated from 1.8 V to 3.3 V.

8.3.9 Bus-Hold Data Inputs

Each data input on this device includes a weak latch that maintains a valid logic level on the input. The state of these latches is unknown at startup and remains unknown until the input has been forced to a valid high or low state. After data has been sent through a channel, the latch then maintains the previous state on the input if the line is left floating. It is not recommended to use pull-up or pull-down resistors together with a bus-hold input, as it may cause undefined inputs to occur which leads to excessive current consumption.

Bus-hold data inputs prevent floating inputs on this device. The *Implications of Slow or Floating CMOS Inputs* application report explains the problems associated with leaving CMOS inputs floating.

These latches remain active at all times, independent of all control signals such as direction control or output enable.

The Bus-Hold Circuit application report has additional details regarding bus-hold inputs.

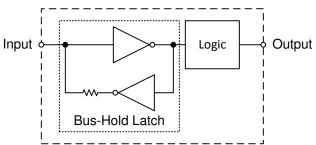


Figure 8-2. Simplified Schematic for Device With Bus-Hold Data Inputs



8.4 Device Functional Modes

Table 8-1 lists the device functions for the DIR input.

Table 8-1. Function Table

| INPUT ⁽¹⁾ DIR | OPERATION |
|-----------------------------|-----------------|
| L | B data to A bus |
| Н | A data to B bus |

(1) Input circuits of the data I/Os always are active.

9 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

9.1 Application Information

The SN74AXCH1T45 device can be used in level-translation applications for interfacing devices or systems with one another when they are operating at different interface voltages. The maximum data rate can be up to 500 Mbps when the device translate signals from 1.8 V to 3.3 V.

9.1.1 Enable Times

Calculate the enable times for the SN74AXC1T45 using the following formulas:

$$t_{A en}$$
 (DIR to A) = t_{dis} (DIR to B) + t_{pd} (B to A) (1)

$$t_{B en}$$
 (DIR to B) = t_{dis} (DIR to A) + t_{pd} (A to B) (2)

In a bidirectional application, these enable times provide the maximum delay time from the time the DIR bit is switched until an output is expected. For example, if the SN74AXCH1T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled (t_{dis}) before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay (t_{pd}) . To avoid bus contention care should be taken to not apply an input signal prior to the output port being disabled (t_{dis}) max).

9.2 Typical Applications

9.2.1 Interrupt Request Application

Figure 9-1 shows an example of the SN74AXCH1T45 being used in an application where a system controller flags an interrupt request (IRQ) to the CPU. The system controller determines the direction of the IRQ line to either flag an interrupt to the CPU or allow the CPU to drive data on the line. In this application the controller is operating at 3.3 V while the CPU can be operating as low as 0.65 V.

The SN74AXCH1T45 device is used to ensure that these devices can communicate at the appropriate voltage levels. Because the SN74AXCH1T45 does not have an output-enable (\overline{OE}) pin, the system designer should take precautions to avoid bus contention between the CPU and controller when changing directions.

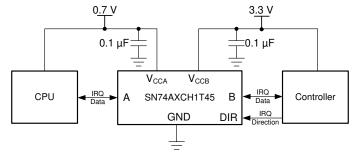


Figure 9-1. Interrupt Request Application



9.2.1.1 Design Requirements

For this design example, use the parameters listed in Table 9-1.

Table 9-1. Design Parameters

| DESIGN PARAMETERS | EXAMPLE VALUES |
|----------------------|-----------------|
| Input voltage range | 0.65 V to 3.6 V |
| Output voltage range | 0.65 V to 3.6 V |

9.2.1.2 Detailed Design Procedure

To begin the design process, determine the following:

- · Input voltage range
 - Use the supply voltage of the device that is driving the SN74AXCH1T45 device to determine the input voltage range. For a valid logic-high, the value must exceed the high-level input voltage (V_{IH}) of the input port. For a valid logic low the value must be less than the low-level input voltage (V_{IL}) of the input port.
- Output voltage range
 - Use the supply voltage of the device that the SN74AXCH1T45 device is driving to determine the output voltage range.

9.2.1.3 Application Curve

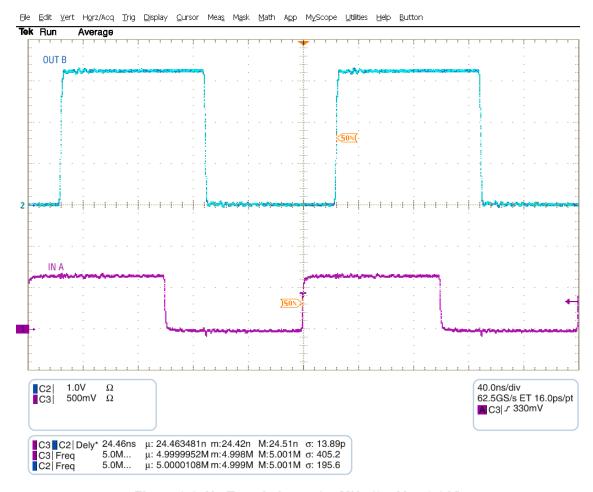


Figure 9-2. Up Translation at 2.5 MHz (0.7 V to 3.3 V)

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9.2.2 Universal Asynchronous Receiver-Transmitter (UART) Interface Application

Figure 9-3 shows the SN74AXCH1T45 being used for the two-bit UART interface application. One SN74AXCH1T45 device is used to level shift the voltage and drive the TX from the processor to the GPS Module while a second SN74AXCH1T45 device is used to drive the TX Data line from the GPS Module to the Processor. Devices with bus-hold inputs remove the requirement for external pullup resistors to maintain a valid logic level at the input.

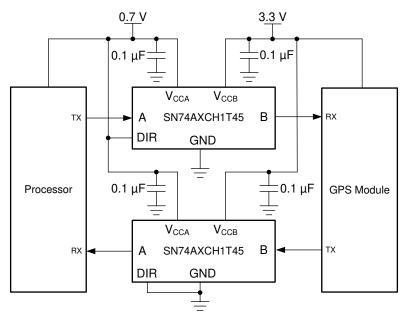


Figure 9-3. UART Interface Application

9.2.2.1 Design Requirements

Refer to Design Requirements.

9.2.2.2 Detailed Design Procedure

Refer to Detailed Design Procedure.



10 Power Supply Recommendations

Always apply a ground reference to the GND pins first. This device is designed for glitch free power sequencing without any supply sequencing requirements such as ramp order or ramp rate.

This device was designed with various power supply sequencing methods in mind to help prevent unintended triggering of downstream devices. For more information regarding the power up glitch performance of the AXC family of level translators, see the *Power Sequencing for AXC Family of Devices* application report.

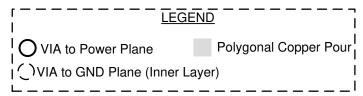
11 Layout

11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines are recommended:

- Use bypass capacitors on the power supply pins and place them as close to the device as possible.
- Use short trace lengths to avoid excessive loading.

11.2 Layout Example



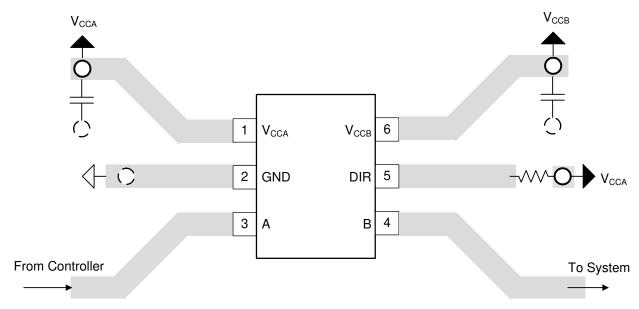


Figure 11-1. PCB Layout Example

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12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, Evaluate SN74AXC1T45DRL Using a Generic EVM application report
- Texas Instruments, System Considerations For Using Bus-hold Circuits To Avoid Floating Inputs application report
- Texas Instruments, Power Sequencing for the AXC Family of Devices application report
- Texas Instruments, Implications of Slow or Floating CMOS Inputs application report

12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.6 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ | MSL rating/ | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|------------------|-----------------------|------|---------------|--------------------|--------------|--------------|
| | (1) | (2) | | | (3) | Ball material | Peak reflow | | (6) |
| | | | | | | (4) | (5) | | |
| SN74AXCH1T45DBVR | Active | Production | SOT-23 (DBV) 6 | 3000 LARGE T&R | Yes | NIPDAU SN | Level-1-260C-UNLIM | -40 to 125 | 1PNL |
| SN74AXCH1T45DBVR.B | Active | Production | SOT-23 (DBV) 6 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 1PNL |
| SN74AXCH1T45DBVRG4 | Active | Production | SOT-23 (DBV) 6 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 1PNL |
| SN74AXCH1T45DBVRG4.B | Active | Production | SOT-23 (DBV) 6 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 1PNL |
| SN74AXCH1T45DCKR | Active | Production | SC70 (DCK) 6 | 3000 LARGE T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 125 | 1CC |
| SN74AXCH1T45DCKR.B | Active | Production | SC70 (DCK) 6 | 3000 LARGE T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 125 | 1CC |
| SN74AXCH1T45DRY2 | Active | Production | SON (DRY) 6 | 5000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | IR |
| SN74AXCH1T45DRY2.B | Active | Production | SON (DRY) 6 | 5000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | IR |
| SN74AXCH1T45DRYR | Active | Production | SON (DRY) 6 | 5000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | II |
| SN74AXCH1T45DRYR.B | Active | Production | SON (DRY) 6 | 5000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | II |
| SN74AXCH1T45DTQR | Active | Production | X2SON (DTQ) 6 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | DM |
| SN74AXCH1T45DTQR.B | Active | Production | X2SON (DTQ) 6 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | DM |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

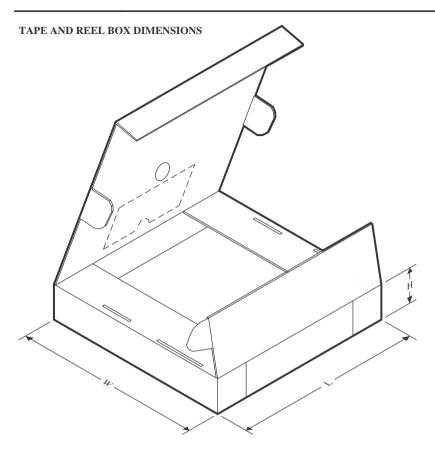


*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AXCH1T45DBVR | SOT-23 | DBV | 6 | 3000 | 180.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| SN74AXCH1T45DBVRG4 | SOT-23 | DBV | 6 | 3000 | 180.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| SN74AXCH1T45DCKR | SC70 | DCK | 6 | 3000 | 180.0 | 8.4 | 2.3 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| SN74AXCH1T45DRY2 | SON | DRY | 6 | 5000 | 180.0 | 9.5 | 1.6 | 1.15 | 0.68 | 4.0 | 8.0 | Q3 |
| SN74AXCH1T45DRYR | SON | DRY | 6 | 5000 | 180.0 | 9.5 | 1.2 | 1.65 | 0.7 | 4.0 | 8.0 | Q1 |
| SN74AXCH1T45DTQR | X2SON | DTQ | 6 | 3000 | 180.0 | 9.5 | 0.94 | 1.13 | 0.5 | 2.0 | 8.0 | Q2 |



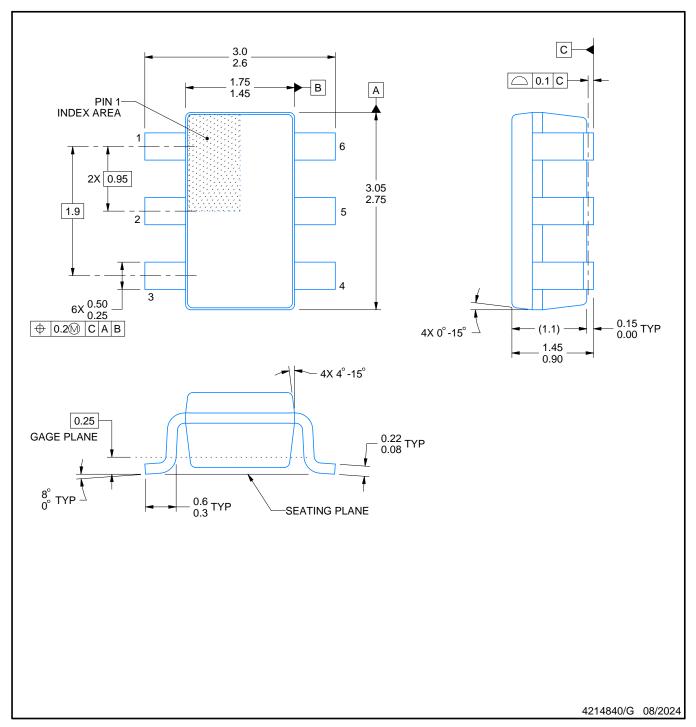
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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AXCH1T45DBVR | SOT-23 | DBV | 6 | 3000 | 210.0 | 185.0 | 35.0 |
| SN74AXCH1T45DBVRG4 | SOT-23 | DBV | 6 | 3000 | 210.0 | 185.0 | 35.0 |
| SN74AXCH1T45DCKR | SC70 | DCK | 6 | 3000 | 210.0 | 185.0 | 35.0 |
| SN74AXCH1T45DRY2 | SON | DRY | 6 | 5000 | 189.0 | 185.0 | 36.0 |
| SN74AXCH1T45DRYR | SON | DRY | 6 | 5000 | 189.0 | 185.0 | 36.0 |
| SN74AXCH1T45DTQR | X2SON | DTQ | 6 | 3000 | 189.0 | 185.0 | 36.0 |





NOTES:

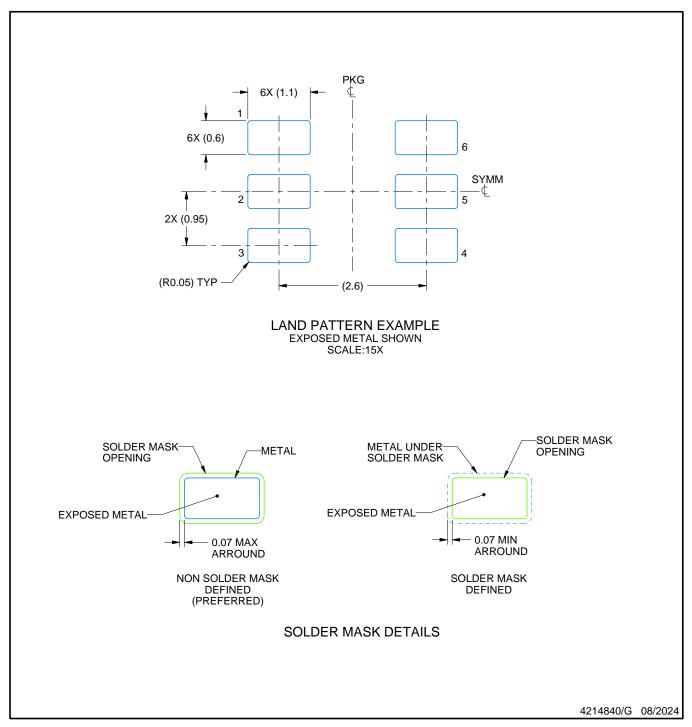
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.

- 4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- 5. Refernce JEDEC MO-178.



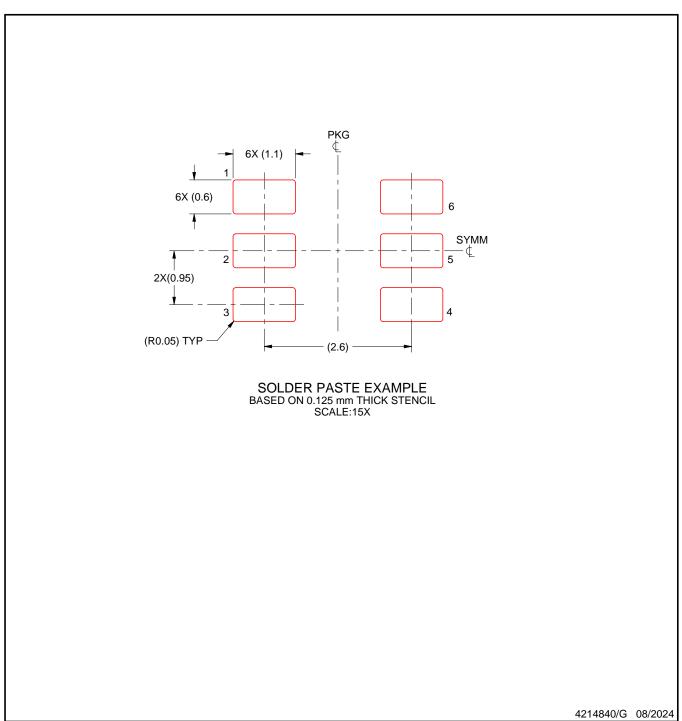


NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



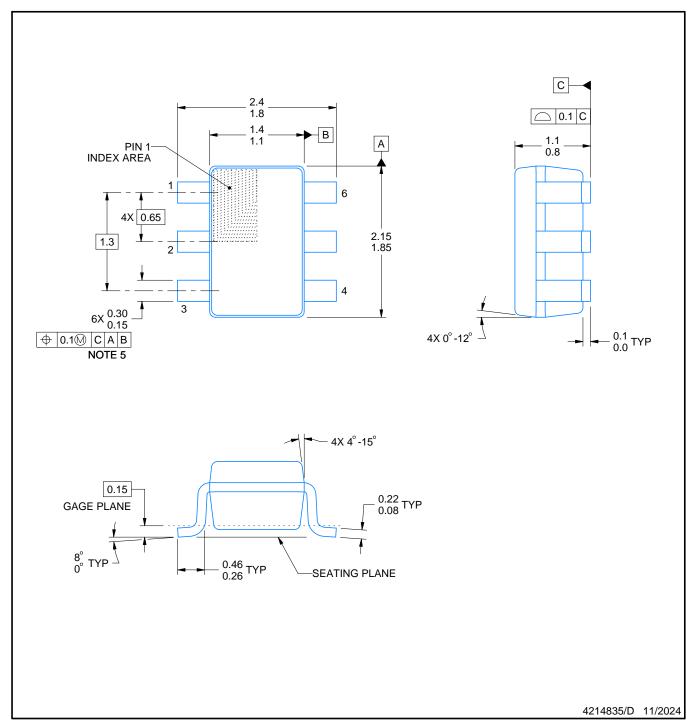


NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.







NOTES:

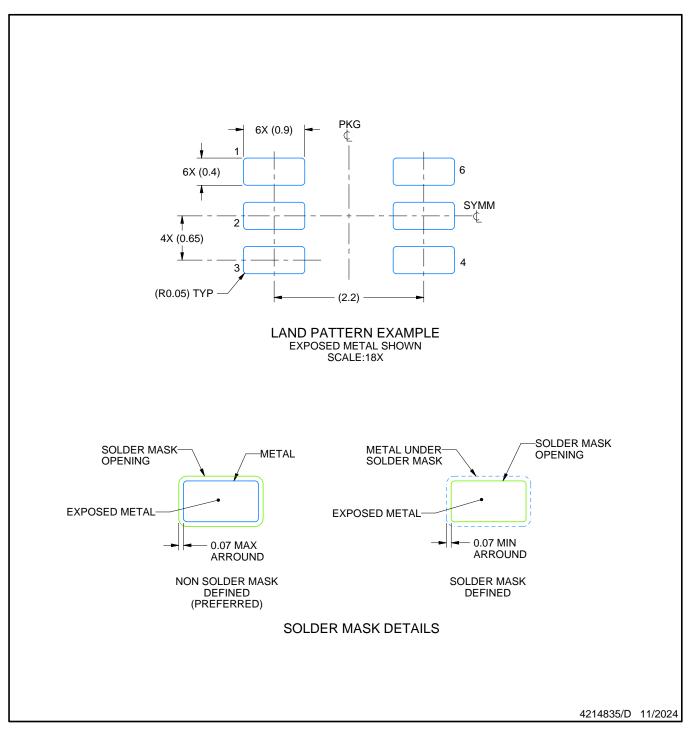
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.

 4. Falls within JEDEC MO-203 variation AB.



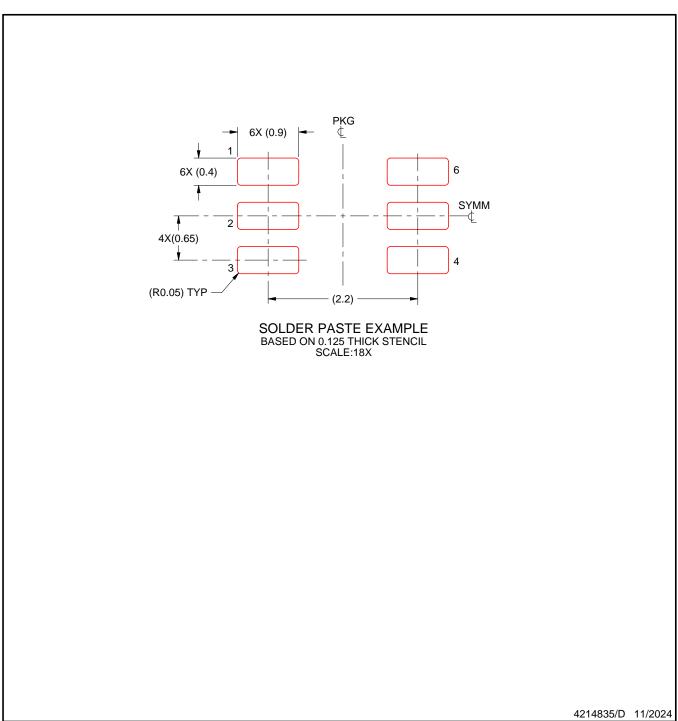


NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



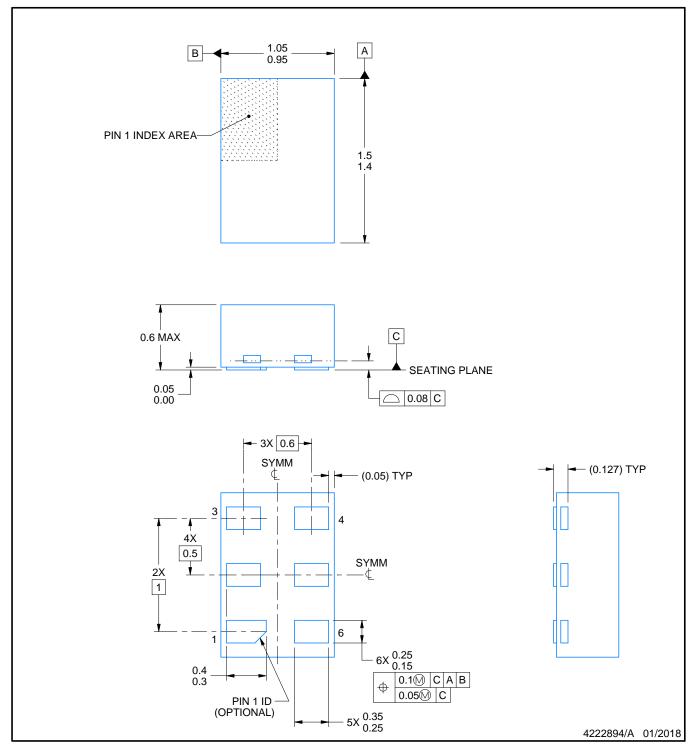


Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.







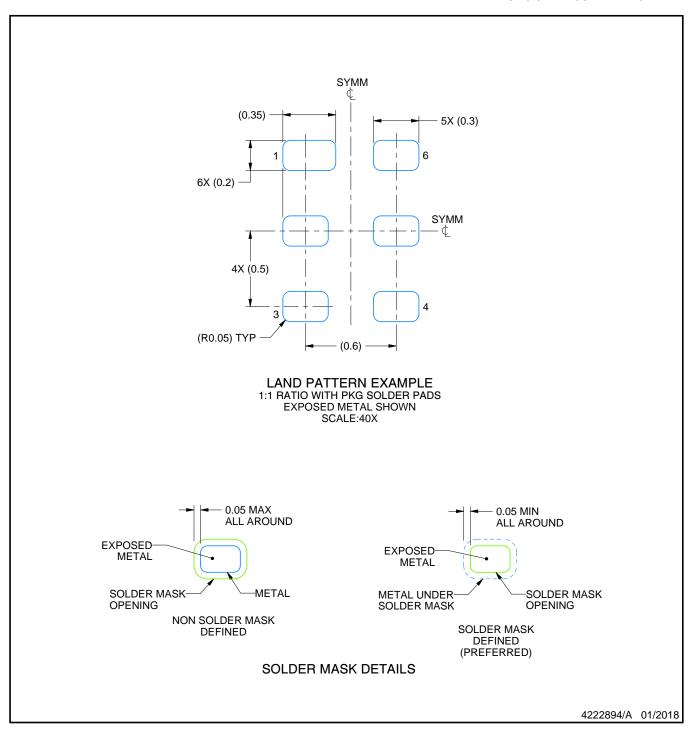


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

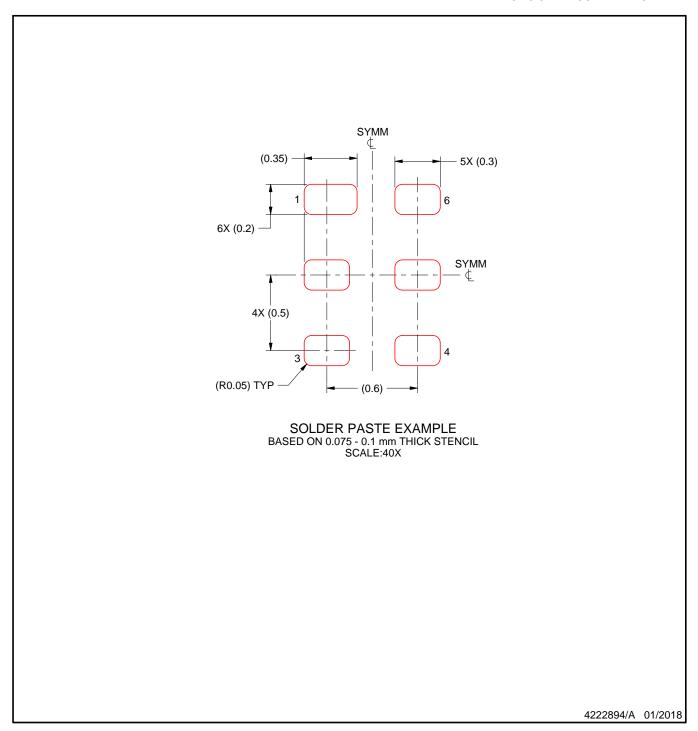




NOTES: (continued)

3. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).



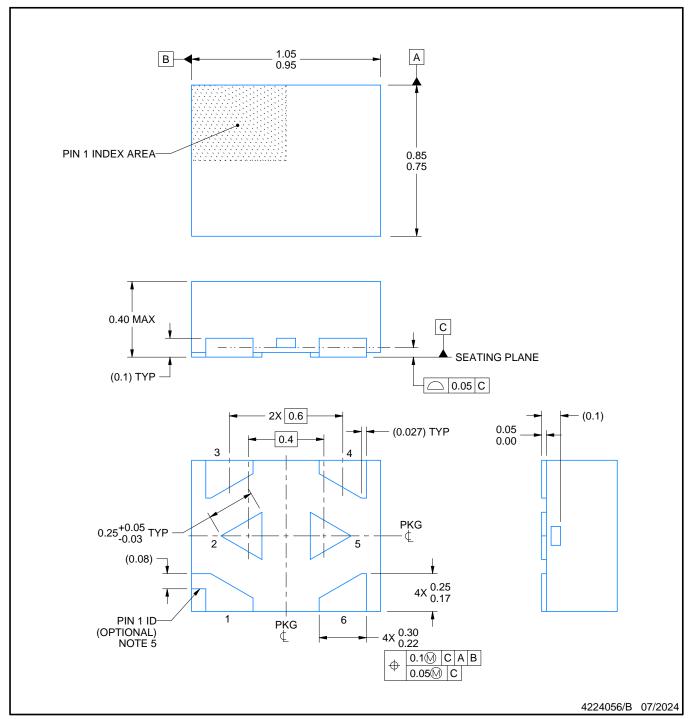


NOTES: (continued)

Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.





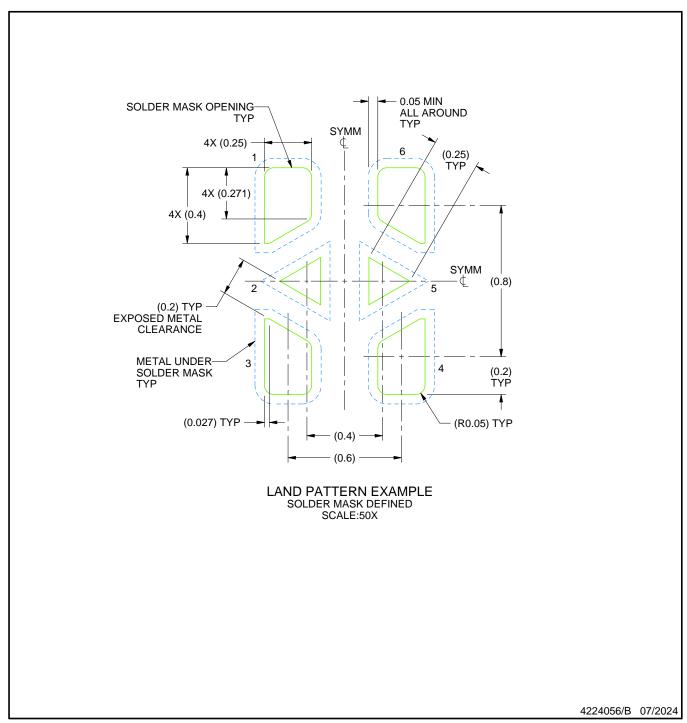


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pads must be soldered to the printed circuit board for optimal thermal and mechanical performance.

 4. The size and shape of this feature may vary.
- 5. Features may not exist. Recommend use of pin 1 marking on top of package for orientation purposes.



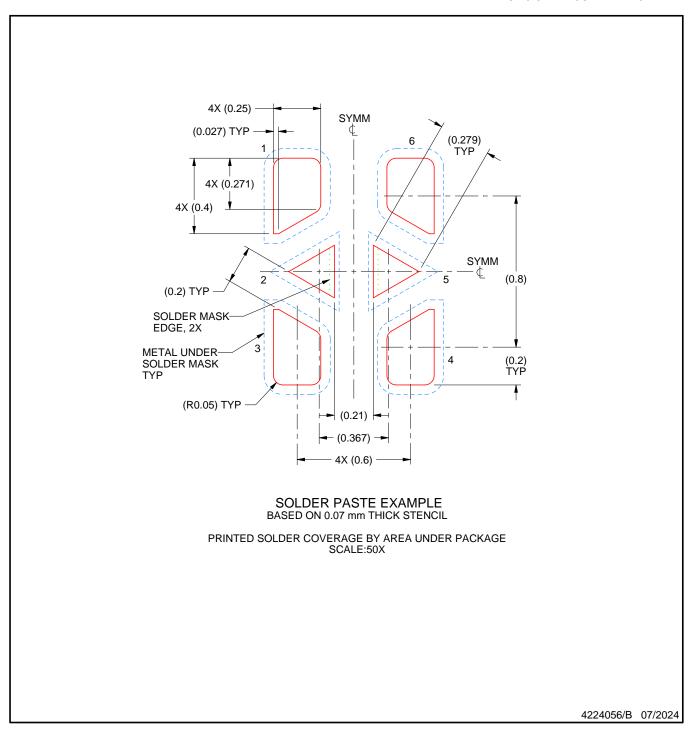


NOTES: (continued)



^{6.} This package is designed to be soldered to a thermal pads on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

^{7.} Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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